

Product Texts

Injection Molding, Unreinforced, Improved Impact

ISO 1043 PA6-I

| Processing/Physical Characteristics | dry / cond | Unit | Test Standard |
|--|-------------------|-------------|----------------------|
| ISO Data | | | |
| ^[C] Molding shrinkage, parallel | 1.3 / * | % | ISO 294-4, 2577 |
| ^[C] Molding shrinkage, normal | 1.4 / * | % | ISO 294-4, 2577 |

[C]: CAMPUS

| Mechanical properties | dry / cond | Unit | Test Standard |
|--|-------------------|-------------------|----------------------|
| ISO Data | | | |
| ^[C] Tensile Modulus | 1800 / 800 | MPa | ISO 527 |
| ^[C] Yield stress | 45 / 35 | MPa | ISO 527 |
| ^[C] Yield strain | 4.5 / 30 | % | ISO 527 |
| ^[C] Nominal strain at break | >50 / >50 | % | ISO 527 |
| ^[C] Charpy impact strength, +23°C | N / N | kJ/m ² | ISO 179/1eU |
| ^[C] Charpy impact strength, -30°C | N / N | kJ/m ² | ISO 179/1eU |
| ^[C] Charpy notched impact strength, +23°C | 85 / 120 | kJ/m ² | ISO 179/1eA |
| ^[C] Charpy notched impact strength, -30°C | 20 / 20 | kJ/m ² | ISO 179/1eA |
| ^[C] Puncture - maximum force, +23°C | 4100 / - | N | ISO 6603-2 |
| ^[C] Puncture - maximum force, -30°C | 4800 / - | N | ISO 6603-2 |
| ^[C] Puncture energy, +23°C | 55 / - | J | ISO 6603-2 |
| ^[C] Puncture energy, -30°C | 60 / - | J | ISO 6603-2 |

[C]: CAMPUS

| Thermal properties | dry / cond | Unit | Test Standard |
|--|-------------------|-------------|----------------------|
| ISO Data | | | |
| ^[C] Melting temperature, 10°C/min | 222 / * | °C | ISO 11357-1/-3 |
| ^[C] Temp. of deflection under load, 1.80 MPa | 50 / * | °C | ISO 75-1/-2 |
| ^[C] Temp. of deflection under load, 0.45 MPa | 90 / * | °C | ISO 75-1/-2 |
| ^[C] Coeff. of linear therm. expansion, parallel | 150 / * | E-6/K | ISO 11359-1/-2 |
| ^[C] Coeff. of linear therm. expansion, normal | 160 / * | E-6/K | ISO 11359-1/-2 |
| ^[C] Burning Behav. at 1.5 mm nom. thickn. | HB / * | class | IEC 60695-11-10 |
| Thickness tested | 1.5 / * | mm | - |
| ^[C] Oxygen index | 21 / * | % | ISO 4589-1/-2 |

[C]: CAMPUS

| Electrical properties | dry / cond | Unit | Test Standard |
|---|-------------------|-------------|----------------------|
| ISO Data | | | |
| ^[C] Relative permittivity, 100Hz | 3.3 / 11 | - | IEC 62631-2-1 |
| ^[C] Relative permittivity, 1MHz | 3 / 3.5 | - | IEC 62631-2-1 |
| ^[C] Dissipation factor, 100Hz | 70 / 1750 | E-4 | IEC 62631-2-1 |
| ^[C] Dissipation factor, 1MHz | 150 / 900 | E-4 | IEC 62631-2-1 |
| ^[C] Volume resistivity | 1E13 / 1E10 | Ohm*m | IEC 62631-3-1 |
| ^[C] Surface resistivity | * / 1E14 | Ohm | IEC 62631-3-2 |
| ^[C] Electric strength | 35 / 35 | kV/mm | IEC 60243-1 |
| ^[C] Comparative tracking index | 600 / - | - | IEC 60112 |

[C]: CAMPUS

| Other properties | dry / cond | Unit | Test Standard |
|------------------------------------|-------------------|-------------------|----------------------|
| ^[C] Water absorption | 7.5 / * | % | Sim. to ISO 62 |
| ^[C] Humidity absorption | 2.2 / * | % | Sim. to ISO 62 |
| ^[C] Density | 1060 / - | kg/m ³ | ISO 1183 |

[C]: CAMPUS

| Test specimen production | Value | Unit | Test Standard |
|--|-------|------|---------------|
| ISO Data | | | |
| ^[C] Injection Molding, melt temperature | 270 | °C | ISO 294 |
| Injection Molding, mold temperature | 80 | °C | ISO 294 |

[C]: CAMPUS

| Processing Recommendation Injection Molding | Value | Unit | Test Standard |
|---|-----------|------|---------------|
| Pre-drying - Temperature | 80 | °C | - |
| Pre-drying - Time | 2 - 6 | h | - |
| Processing humidity | ≤0.12 | % | - |
| Melt temperature | 260 - 280 | °C | - |
| Mold temperature | 80 - 90 | °C | - |

Characteristics

Processing

Injection Molding

Delivery form

Pellets

Additives

Release agent

Special Characteristics

High impact or impact modified

Regional Availability

North America, Europe, Asia Pacific, South and Central America, Near East/Africa

Other text information

Injection molding

PREPROCESSING

Residual moisture content: 0.03 - 0.12%

Drying temperature dry air dryer: 80 °C

Drying time dry air dryer 2 - 6 h

PROCESSING

Melt temperature (Tmin - Tmax): 260 - 280 °C

Mold temperature: 80 - 90 °C